



GoldStar
GOLDSTAR ELECTRON CO., LTD.

GM76C256AL/ALL

32,768 WORDS × 8 BIT
CMOS STATIC RAM

Description

The GM76C256AL/ALL is a 262,144 bit static random access memory organized as 32,768 words by 8 bits using CMOS technology, and operated from a single 5V supply. Advanced circuit techniques provide both high speed and low power features with an operating current of 50mA (max) at minimum cycle time of 70ns.

When $\overline{CS}$ is a logical high, the device is placed in low power standby mode in which standby current is 1mA (max).

The GM76C256AL/ALL has two control inputs. Chip select ($\overline{CS}$) allows for device selection and data retention control, and output enable ($\overline{OE}$) provides fast memory access.

Thus the GM76C256AL/ALL is suitable for use in various microprocessor application systems where high speed, low power, and battery back up are required. The GM76C256AL/ALL is offered in 28 pin DIP (600 mil), SOP (330 mil) and TSOP 1 (0814).

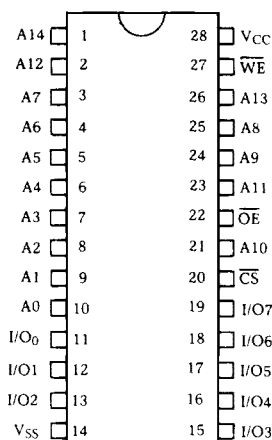
Features

- High Speed: Fast Access and Cycle Time 70/85/100ns Max.
- Low Power Standby and Low Power Operation; Stand by: 0.55mW Max. (Low Power Version) Stand by: 0.17mW Max. (Low Low Power Version) Operation: 275mW Max.
- Completely Static RAM: No Clock or Timing Strobe Required
- Equal Access and Cycle Time
- Capability of Battery Back up Operation
- Standard 28 DIP, SOP and TSOP I

Pin Description

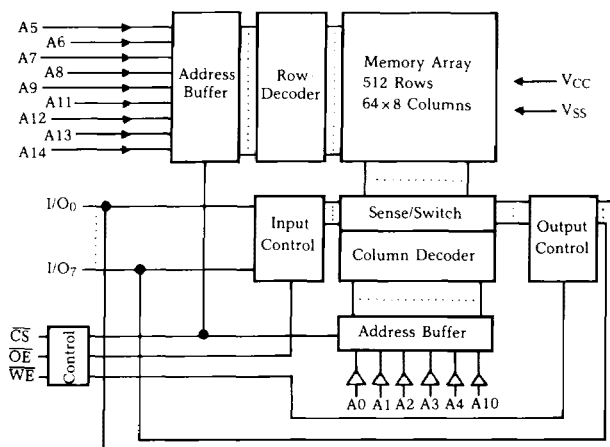
Pin	Function
A0 ~ A14	Address Inputs
$\overline{WE}$	Write Enable Input
$\overline{OE}$	Output Enable Input
$\overline{CS}$	Chip Select Input
I/O0 ~ I/O7	Data Input/Output
V _{CC}	Power Supply +5V
V _{SS}	Ground

Pin Configuration



(Top View)

Block Diagram



Absolute Maximum Ratings*

Symbol	Parameter	Rating	Unit
T _A	Ambient Temperature under Bias	0 ~ 70	°C
T _{STG}	Storage Temperature	-65 ~ 150	°C
T _{SOL}	Soldering Temperature and Time	260, 10 [at lead]	°C, S
V _{CC}	Supply Voltage	-0.3 ~ 7.0	V
V _{IN}	Input Voltage	-0.3* ~ 7.0	V
V _{I/O}	Input and Output Voltage	-0.5 ~ V _{CC} + 0.5	V
P _D	Power Dissipation	1.0	W

*: -3.0V at pulse width 50ns Max.

Recommended Operating Conditions (T_A = 0 ~ 70°C)

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	4.5	5.0	5.5	V
V _{IH}	Input High Voltage	2.2	—	V _{CC} + 0.3	V
V _{IL}	Input Low Voltage	-0.3	—	0.8	V
V _{DR}	Data Retention Supply Voltage	2.0	—	5.5	V

Truth Table

$\overline{CS}$	$\overline{WE}$	$\overline{OE}$	Input/Output	Mode
H	X	X	High Z	Deselect Power Down
L	H	L	Data Out	Read
L	L	X	Data In	Write
L	H	H	High Z	Deselect

Note: X means don't care

DC Electrical Characteristics: (V_{CC} = 5V ± 10%, T_A = 0 ~ 70°C)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V _{OH}	Output High Voltage	I _{OH} = -1.0mA	2.4	—	—	V
V _{OL}	Output Low Voltage	I _{OL} = 2.1mA	—	—	0.4	V
I _{I(L)}	Input Leakage Current	V _{SS} ≤ V _{IN} ≤ V _{CC}	-1	—	1	μA
I _{O(L)}	Output Leakage Current	$\overline{CS} = V_{IH}$ or $\overline{WE} = V_{IL}$ or $\overline{OE} = V_{IH}$, V _{SS} ≤ V _{OUT} ≤ V _{CC}	-1	—	1	μA
I _{CCS1}	Stand-by Power Supply Current	$\overline{CS} = V_{IH}$	—	—	1	mA
I _{CCS2}		$\overline{CS} \geq V_{CC} - 0.2V$ GM76C256AL GM76C256ALL	— —	2* 1*	100 20	μA
I _{CC}	Operating Supply Current	$\overline{CS} = V_{IL}$, V _{I/O} = 0mA	—	7	15	mA
I _{CC1}	Average Operating Power Supply Current	Min. Cycle, duty = 100% I _{I/O} = 0mA	—	—	50	mA

*TYP. Values are measured at 25°C, V_{CC} = 5V

AC Operating Characteristics ($V_{CC}=5V \pm 10\%$, $T_A = 0 \sim 70^\circ\text{C}$)

Read Cycle

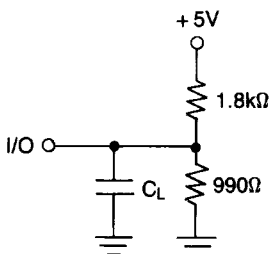
Symbol	Parameter	Conditions	GM76C256AL-70		GM76C256AL-85		GM76C256AL-10		Unit
			Min	Max	Min	Max	Min	Max	
t_{RC}	Read Cycle Time	*1	70	—	85	—	100	—	ns
t_{AA}	Address Access Time		—	70	—	85	—	100	ns
t_{ACS}	Chip Select Access Time		—	70	—	85	—	100	ns
t_{OE}	Output Enable to Output Valid		—	35	—	45	—	50	ns
t_{OH}	Output Hold from Address Change		5	—	5	—	10	—	ns
t_{CLZ}	Chip Selection to Output in Low-Z	*2	10	—	10	—	10	—	ns
t_{OLZ}	Output Enable to Output in Low-Z		5	—	5	—	5	—	ns
t_{CHZ}	Chip Deselection to Output in High-Z		0	30	0	30	0	35	ns
t_{OHZ}	Output Disable to Output in High-Z		0	30	0	30	0	35	ns

Write Cycle

Symbol	Parameter	Conditions	GM76C256AL-70		GM76C256AL-85		GM76C256AL-10		Unit
			Min	Max	Min	Max	Min	Max	
t_{WC}	Write Cycle Time	*1	70	—	85	—	100	—	ns
t_{CW}	Chip Selection to End of Write		60	—	75	—	80	—	ns
t_{AW}	Address Valid to End of Write		60	—	75	—	80	—	ns
t_{AS}	Address Setup Time		0	—	0	—	0	—	ns
t_{WP}	Write Pulse Width		50	—	60	—	60	—	ns
t_{WR}	Write Recovery Time		0	—	5	—	5	—	ns
t_{DW}	Data to Write Time Overlap		30	—	40	—	40	—	ns
t_{DH}	Data Hold from Write Time		0	—	0	—	0	—	ns
t_{WHZ}	Write to Output in High-Z	*2	0	25	0	30	0	35	ns
t_{OW}	Output Active from End of Write		5	—	5	—	5	—	ns

*1 Test Conditions

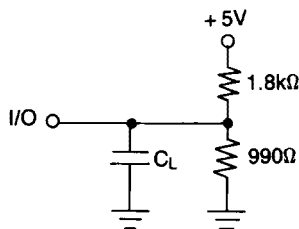
1. Input pulse level: 0.6V to 2.4V
2. $t_r = t_f = 5\text{ns}$
3. Input and output timing reference levels: 1.5V
4. Output load $C_L = 100\text{pF}$



$C_L = 100\text{pF}$ (Includes Jig Capacitance)

*2 Test Conditions

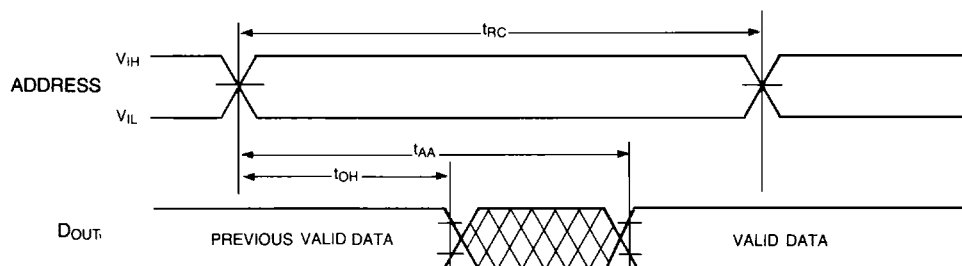
1. Input pulse level: 0.6V to 2.4V
2. $t_r = t_f = 5\text{ns}$
3. Input timing reference level: 0.8V to 2.2V.
4. Output timing reference levels:
 $\pm 200\text{mV}$ (the level displace from stable output voltage level)
5. Output load $C_L = 5\text{pF}$



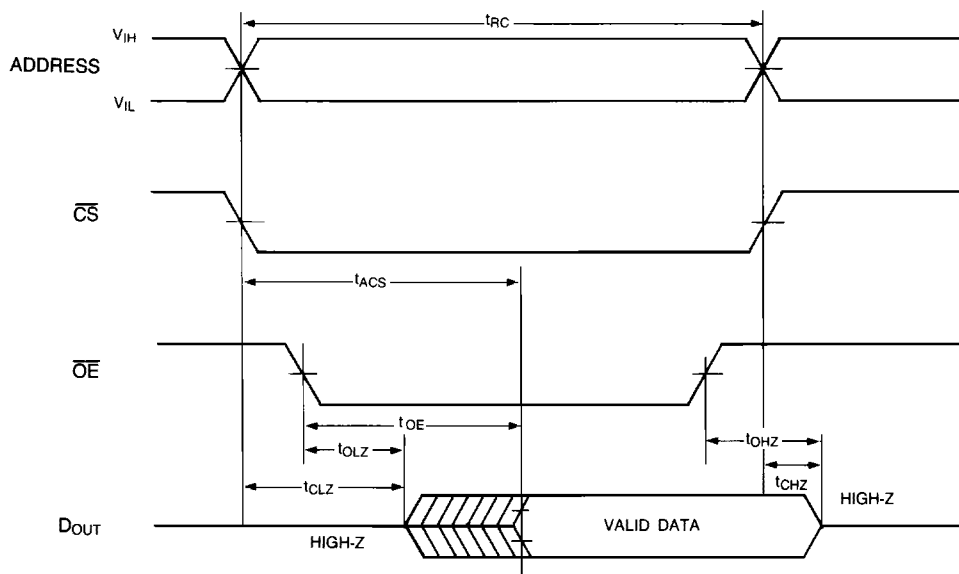
$C_L = 5\text{pF}$ (Includes Jig Capacitance)

TIMING WAVEFORMS

Read Cycle 1 (Notes 1, 3)



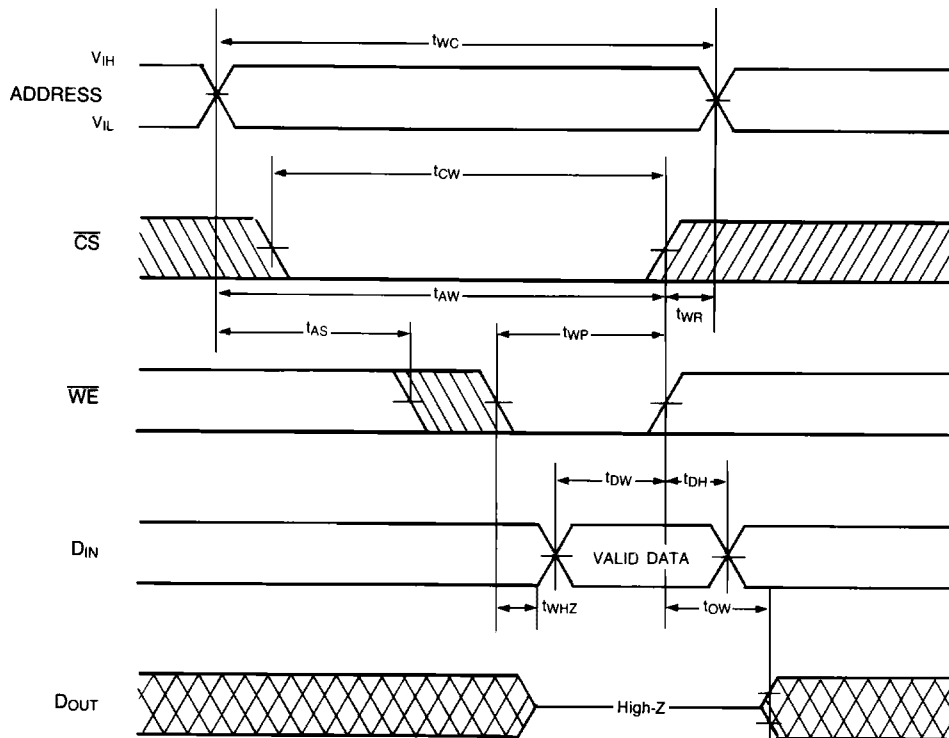
Read Cycle 2 (Notes 2, 3)



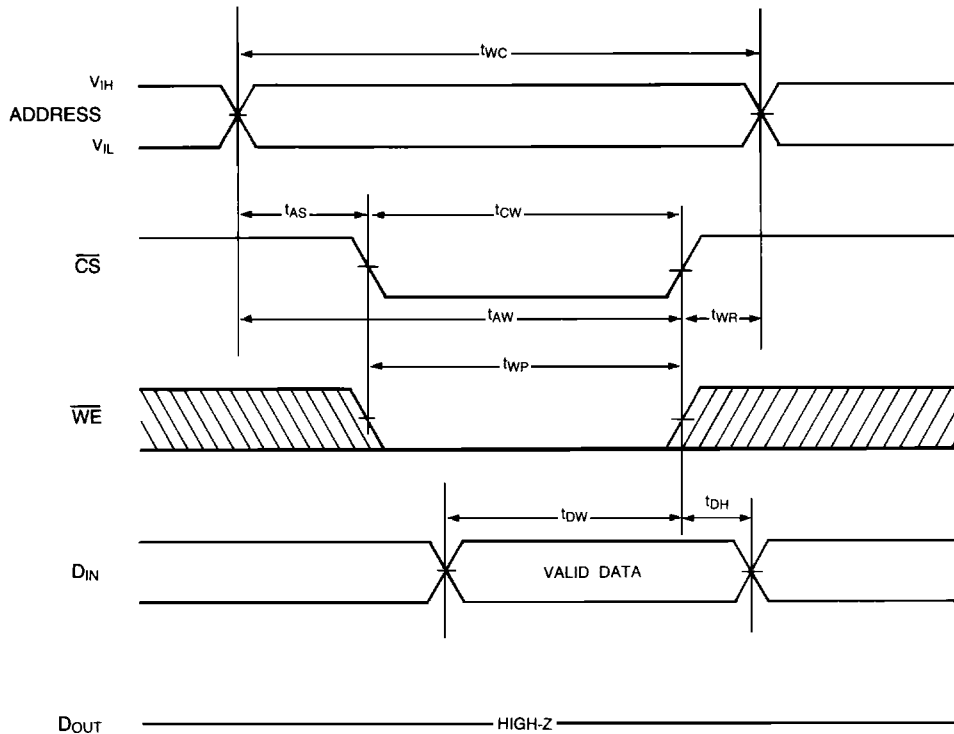
Notes:

1. Device is continuously selected. $\overline{OE}$, $\overline{CS} = V_{IL}$.
2. Address valid prior to or coincident with $\overline{CS}$ transition low.
3. $\overline{WE}$ is high for read cycle.

Write Cycle 1 ($\overline{WE}$ Controlled) (Note 1, 2)



Write Cycle 2 ($\overline{CS}$ Controlled) (Note 1, 2, 3)



Notes:

1. The internal write time of the memory is defined by the overlap of $\overline{CS}$ low and $\overline{WE}$ low. Both signals must be low to initiate a write and either signal can terminate a write by going high. The data input setup and hold timing should be referenced to the rising edge of the signal that terminates the write.
2. Data I/O is high impedance if $\overline{OE} = V_{IH}$
3. If $\overline{CS}$ goes high simultaneously with $\overline{WE}$ high, the output remains in a high impedance state.

Capacitance

Symbol	Parameter	Test Condition	Min	Max	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1MHz V _{CC} = 5.0V	—	6	pF
C _{OUT}	Output Capacitance		—	8	

Note: Tested on a sample basis

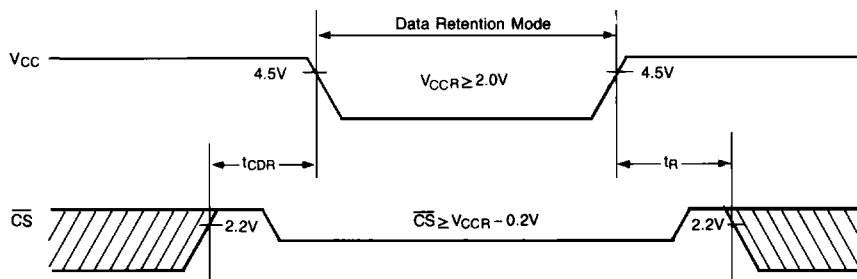
Data Retention Characteristics: (T_A = 0° ~ 70°C)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V _{CCR}	Data Retention Supply Voltage	$\overline{CS} \geq V_{CC} - 0.2V$	2.0	—	5.5	V
I _{CCR}	Data Retention Current	V _{CC} = 3.0V $\overline{CS} \geq 2.8V$	—	1**	50	μA
		ALL	—	0.5**	10	
t _{CDR}	Chip Select Data Hold Time	Refer to the figure below	0	—	—	ns
t _R	Operation Recovery Time		t _{RC} *	—	—	ns

Note* : Read Cycle Time

Note**: Typ, Values are measured at 25°C.

Data Retention Timing

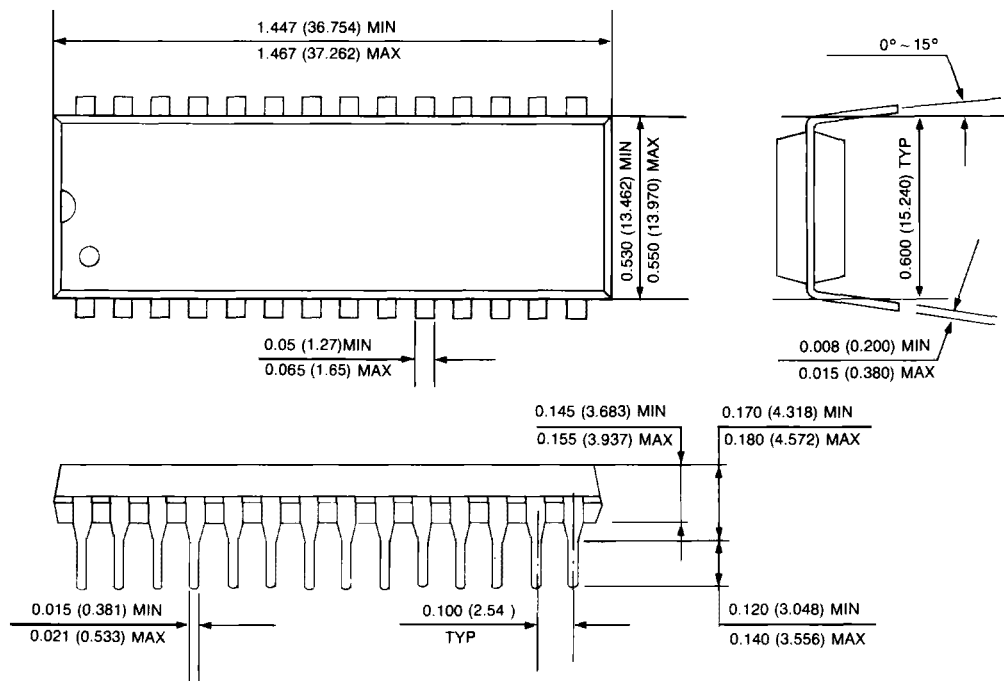


Note: When retaining data in standby mode, supply voltage can be lowered within a certain range. Read or write cycle cannot be performed while the supply voltage is low.

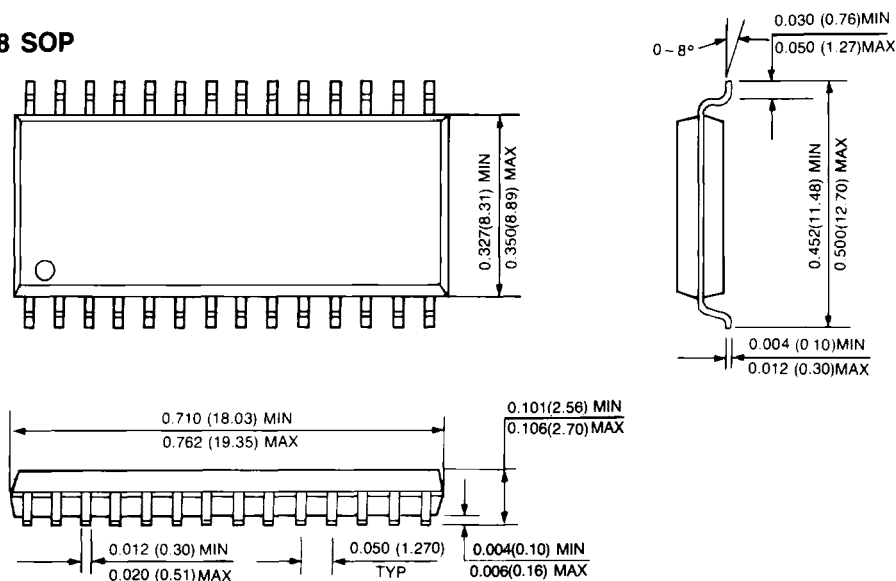
Package Dimensions

28 DIP

Unit: inches (mm)



28 SOP



28 TSOP

Unit: inches (mm)

